

Specifications HA-5222/883

Absolute Maximum Ratings

Voltage Between V+ and V- Terminals	36V
Differential Input Voltage	5V
Voltage at Either Input Terminal	V+ to V-
Peak Output Current (Pulsed at 1ms, 10% Duty Cycle)	100mA
Continuous Output Current	Short Circuit Protected
Junction Temperature	+175°C
Storage Temperature Range	-65°C to +150°C
ESD Rating	<2000V
Lead Temperature (Soldering 10s)	+300°C

Thermal Information (Typical)

Thermal Resistance	θ_{JA}	θ_{JC}
CerDIP Package	96°C/W	16°C/W
Package Power Dissipation Limit at +75°C		
CerDIP Package	1.04W	
Package Power Dissipation Derating Factor Above +75°C		
CerDIP Package	10.4mW/°C	

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Operating Conditions

Operating Temperature Range	-55°C to +125°C	$V_{INCM} \leq 1/2 (V+ - V-)$
Operating Supply Voltage	$\pm 5V$ to $\pm 15V$	$R_L \geq 1k\Omega$

TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS

Device Tested at: $V_{SUPPLY} = \pm 15V$, $R_{LOAD} = 1k\Omega$, $V_{OUT} = 0V$, Unless Otherwise Specified.

PARAMETERS	SYMBOL	CONDITIONS	GROUP A SUBGROUPS	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Input Offset Voltage	V_{IO}	$V_{CM} = 0V$	1	+25°C	-0.75	0.75	mV
			2, 3	+125°C, -55°C	-1.5	1.5	mV
Input Bias Current	+ I_B	$V_{CM} = 0V$, + $R_S = 100.1k\Omega$, - $R_S = 100\Omega$	1	+25°C	-80	80	nA
			2, 3	+125°C, -55°C	-200	200	nA
	- I_B	$V_{CM} = 0V$, + $R_S = 100\Omega$, - $R_S = 100.1k\Omega$	1	+25°C	-80	80	nA
			2, 3	+125°C, -55°C	-200	200	nA
Input Offset Current	I_{IO}	$V_{CM} = 0V$, + $R_S = 100.1k\Omega$, - $R_S = 100.1k\Omega$	1	+25°C	-50	50	nA
			2, 3	+125°C, -55°C	-150	150	nA
Common Mode Range	+CMR	$V+ = +3V$, $V- = -27V$	1	+25°C	12	-	V
			2, 3	+125°C, -55°C	12	-	V
	-CMR	$V+ = +27V$, $V- = -3V$	1	+25°C	-	-12	V
			2, 3	+125°C, -55°C	-	-12	V
Large Signal Voltage Gain	+ A_{VOL}	$V_{OUT} = 0V$ and +10V	4	+25°C	106	-	dB
			5, 6	+125°C, -55°C	100	-	dB
	- A_{VOL}	$V_{OUT} = 0V$ and -10V	4	+25°C	106	-	dB
			5, 6	+125°C, -55°C	100	-	dB
Common Mode Rejection Ratio	+CMRR	$\Delta V_{CM} = +10V$, $V+ = +5V$, $V- = -25V$, $V_{OUT} = -10V$	1	+25°C	88	-	dB
			2, 3	+125°C, -55°C	86	-	dB
	-CMRR	$\Delta V_{CM} = -10V$, $V+ = +25V$, $V- = -5V$, $V_{OUT} = +10V$	1	+25°C	88	-	dB
			2, 3	+125°C, -55°C	86	-	dB
Output Voltage Swing	+ V_{OUT}	$R_L = 1k\Omega$	4	+25°C	12.0	-	V
			5, 6	+125°C, -55°C	11.5	-	V
	- V_{OUT}	$R_L = 1k\Omega$	4	+25°C	-	-12.0	V
			5, 6	+125°C, -55°C	-	-11.5	V

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TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS (Continued)

Device Tested at: $V_{SUPPLY} = \pm 15V$, $R_{LOAD} = 1k\Omega$, $V_{OUT} = 0V$, Unless Otherwise Specified.

PARAMETERS	SYMBOL	CONDITIONS	GROUP A SUBGROUPS	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Output Current	+I _{OUT}	V _{OUT} = +10V, R _L = 1kΩ	4	+25°C	30	-	mA
			5, 6	+125°C, -55°C	30	-	mA
	-I _{OUT}	V _{OUT} = -10V, R _L = 1kΩ	4	+25°C	-	-30	mA
			5, 6	+125°C, -55°C	-	-30	mA
Quiescent Power Supply Current	+I _{CC}	V _{OUT} = 0V, I _{OUT} = 0mA	1	+25°C	-	20	mA
			2, 3	+125°C, -55°C	-	22	mA
	-I _{CC}	V _{OUT} = 0V, I _{OUT} = 0mA	1	+25°C	-20	-	mA
			2, 3	+125°C, -55°C	-22	-	mA
Power Supply Rejection Ratio	+PSRR	$\Delta V_{SUP} = 10V$, V ₊ = +20V, V ₋ = -15V, V ₊ = +10V, V ₋ = -15V	1	+25°C	90	-	dB
			2, 3	+125°C, -55°C	86	-	dB
	-PSRR	$\Delta V_{SUP} = 10V$, V ₊ = +15V, V ₋ = -20V, V ₊ = +15V, V ₋ = -10V	1	+25°C	90	-	dB
			2, 3	+125°C, -55°C	86	-	dB

TABLE 2. AC ELECTRICAL PERFORMANCE CHARACTERISTICS

Table 2 Intentionally Left Blank. See AC Specifications in Table 3.

TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTIC

Device Characterized at: $V_{SUPPLY} = \pm 15V$, $R_{LOAD} = 1k\Omega$, Unless Otherwise Specified.

PARAMETERS	SYMBOL	CONDITIONS	NOTES	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Input Noise Voltage Density	E _N	R _S = 0Ω, f _O = 10Hz	1, 5	+25°C	-	16.0	nV/√Hz
		R _S = 0Ω, f _O = 100Hz	1, 5	+25°C	-	6.6	nV/√Hz
		R _S = 0Ω, f _O = 1kHz	1, 5	+25°C	-	5.9	nV/√Hz
Input Noise Current Density	I _N	R _S = 500kΩ, f _O = 10Hz	1, 5	+25°C	-	24.0	pA/√Hz
		R _S = 500kΩ, f _O = 100Hz	1, 5	+25°C	-	6.6	pA/√Hz
		R _S = 500kΩ, f _O = 1kHz	1, 5	+25°C	-	2.7	pA/√Hz
Gain Bandwidth Product	GBWP	V _{OUT} = 200mV _{P-P} , f _O = 100kHz	1	+25°C	100	-	MHz
				-55°C to +125°C	88	-	MHz
Unity Gain Bandwidth	UGBW	V _{OUT} = 200mV	1	+25°C	30	-	MHz
				-55°C to +125°C	25	-	MHz
Slew Rate	±SR	V _{OUT} = ±2.5V, C _L = 50pF	1	-55°C to +125°C	25	-	V/μs
Full Power Bandwidth	FPBW	V _{PEAK} = 10V	1, 2	-55°C to +125°C	398	-	kHz

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TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTIC (Continued)

Device Characterized at: $V_{SUPPLY} = \pm 15V$, $R_{LOAD} = 1k\Omega$, Unless Otherwise Specified.

PARAMETERS	SYMBOL	CONDITIONS	NOTES	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Minimum Closed Loop Stable Gain	CLSG	$R_L = 1k\Omega$, $C_L = 50pF$	1	-55°C to +125°C	1	-	V/V
Rise and Fall Time	t_R , t_F	$V_{OUT} = \pm 100mV$	1, 4	+25°C	-	20	ns
				-55°C to +125°C	-	35	ns
Overshoot	$\pm OS$	$V_{OUT} = \pm 100mV$	1	+25°C	-	25	%
				-55°C to +125°C	-	30	%
Power Consumption	PC	$V_{OUT} = 0V$, $I_{OUT} = 0mA$	1, 3	-55°C to +125°C	-	660	mW

NOTES:

1. Parameters listed in Table 3 are controlled via design or process parameters and are not directly tested at final production. These parameters are lab characterized upon initial design release, or upon design changes. These parameters are guaranteed by characterization based upon data from multiple production runs which reflect lot to lot and within lot variation.
2. Full Power Bandwidth guarantee based on Slew Rate measurement using $FPBW = \text{Slew Rate}/(2\pi V_{PEAK})$.
3. Power Consumption based upon Quiescent Supply Current test maximum. (No load on outputs.).
4. Measured between 10% and 90% points.
5. Input Noise Voltage Density and Input Noise Current Density limits are based on characterization data.

TABLE 4. ELECTRICAL TEST REQUIREMENTS

MIL-STD-883 TEST REQUIREMENTS	SUBGROUPS (SEE TABLE 1)
Interim Electrical Parameters (Pre Burn-In)	1
Final Electrical Test Parameters	1 (Note 1), 2, 3, 4, 5, 6
Group A Test Requirements	1, 2, 3, 4, 5, 6
Groups C and D Endpoints	1

NOTE:

1. PDA applies to Subgroup 1 only.

Die Characteristics

DIE DIMENSIONS:

78 x 185 x 19 mils ± 1 mils
 1980 x 4690 x 483µm ± 25.4µm

METALLIZATION:

Type: Al, 1% Cu
 Thickness: 16kÅ ± 2kÅ

GLASSIVATION:

Type: Nitride (Si3N4) over Silox (SiO2 5% Phos.)
 Silox Thickness: 12kÅ ± 2kÅ
 Nitride Thickness: 3.5kÅ ± 1.5kÅ

WORST CASE CURRENT DENSITY:

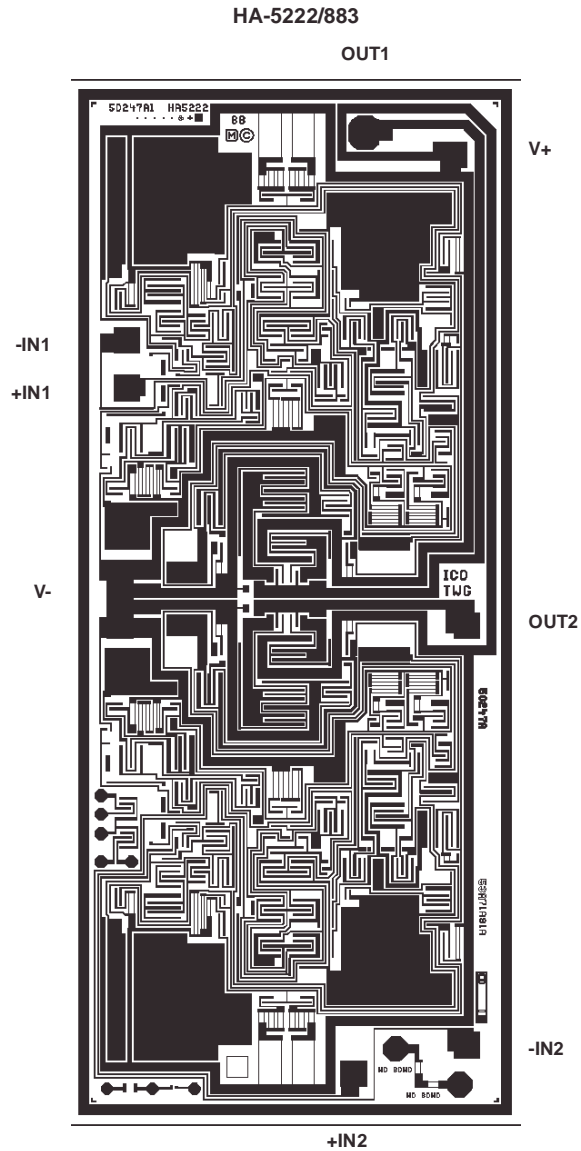
4.2 x 10⁴A/cm²

SUBSTRATE POTENTIAL (Powered Up): V-

TRANSISTOR COUNT: 128

PROCESS: Bipolar Dielectric Isolation

Metallization Mask Layout

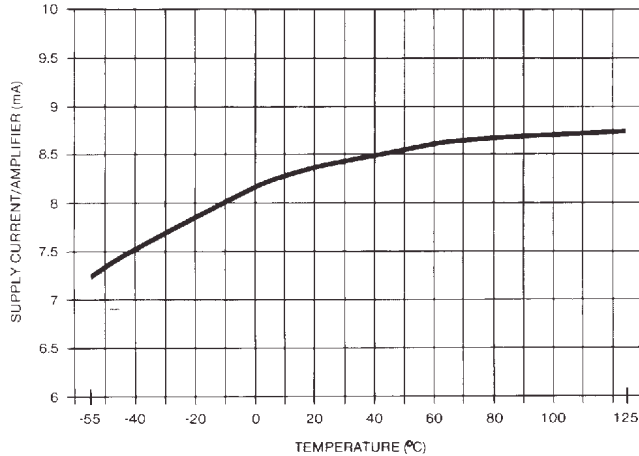


DESIGN INFORMATION (Continued)

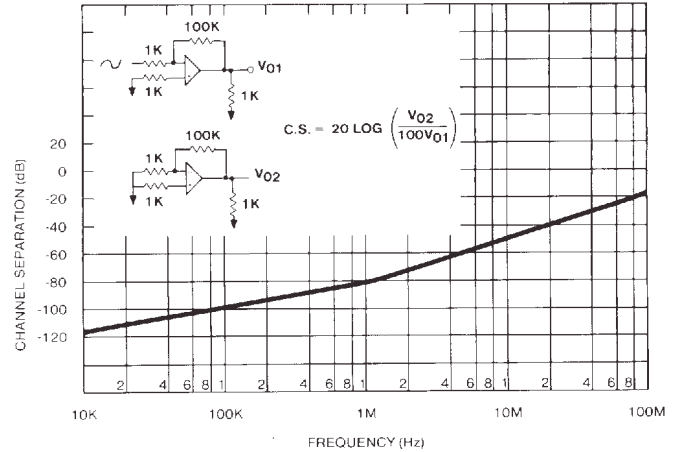
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Typical Performance Curves Unless Otherwise Specified: $T_A = +25^\circ\text{C}$, $V_{\text{SUPPLY}} = \pm 15\text{V}$

SUPPLY CURRENT/AMPLIFIER vs TEMPERATURE



CHANNEL SEPARATION vs FREQUENCY



TYPICAL PERFORMANCE CHARACTERISTICS

Device Characterized at: Supply Voltage = $\pm 15\text{V}$, $R_L = 1\text{k}\Omega$, $C_L = 50\text{pF}$, Unless Otherwise Specified

PARAMETERS	CONDITIONS	TEMPERATURE	TYPICAL	UNITS
Input Offset Voltage	See Table 1	+25°C	0.30	mV
		Full	0.35	mV
Average Offset Voltage Drift	See Table 1	Full	0.50	$\mu\text{V}/^\circ\text{C}$
Input Bias Current	See Table 1	+25°C	40	nA
		Full	70	nA
Input Offset Current	See Table 1	+25°C	15	nA
		Full	30	nA
Differential Input Resistance	See Table 1	+25°C	70	k Ω
Input Noise Voltage	$f_O = 0.1\text{Hz to }10\text{Hz}$	+25°C	0.33	$\mu\text{V}_{\text{p.p}}$
Input Noise Voltage Density	$f_O = 10\text{Hz}$	+25°C	6.4	$\text{nV}/\sqrt{\text{Hz}}$
	$f_O = 100\text{Hz}$	+25°C	3.7	$\text{nV}/\sqrt{\text{Hz}}$
	$f_O = 1\text{kHz}$	+25°C	3.3	$\text{nV}/\sqrt{\text{Hz}}$
Input Noise Current Density	$f_O = 10\text{Hz}$	+25°C	8	$\text{pA}/\sqrt{\text{Hz}}$
	$f_O = 100\text{Hz}$	+25°C	2.7	$\text{pA}/\sqrt{\text{Hz}}$
	$f_O = 1\text{kHz}$	+25°C	1.3	$\text{pA}/\sqrt{\text{Hz}}$
THD & N	See Note 1	+25°C	0.005	%
Large Signal Voltage Gain	$V_{\text{OUT}} = 0\text{V to } \pm 10\text{V}$	+25°C	128	dB
		Full	120	dB

DESIGN INFORMATION (Continued)

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TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

Device Characterized at: Supply Voltage = $\pm 15V$, $R_L = 1k\Omega$, $C_L = 50pF$, Unless Otherwise Specified

PARAMETERS	CONDITIONS	TEMPERATURE	TYPICAL	UNITS	
Common Mode Rejection Ratio	$\Delta V_{CM} = \pm 10V$	Full	95	dB	
Unity Gain Bandwidth	-3dB	+25°C	40	MHz	
		+125°C	33	MHz	
		-55°C	50	MHz	
Gain Bandwidth Product	1kHz to 400kHz	+25°C	140	MHz	
		+125°C	115	MHz	
		-55°C	160	MHz	
Minimum Gain Stability		Full	1	V/V	
Output Voltage Swing	$R_L = 333\Omega$	Full	110	V	
	$R_L = 1K$	+25°C	112.5	V	
		Full	112.1	V	
Output Current	$V_{OUT} = \pm 10V$	Full	156	mA	
Output Resistance		+25°C	10	V	
Full Power Bandwidth	FPBW = $SR/2\pi V_{PEAK}$, $V_{PEAK} = 10V$	+25°C	398	kHz	
Channel Separation	$f_O = 10kHz$	+25°C	110	dB	
Slew Rate	$V_{OUT} = \pm 2.5V$	+25°C	37	V/ μs	
		+125°C	39	V/ μs	
		-55°C	36	V/ μs	
Rise Time	$V_{OUT} = \pm 100mV$	+25°C	16	ns	
		+125°C	17	ns	
		-55°C	17	ns	
Overshoot	$V_{OUT} = \pm 100mV$	+25°C	12	%	
		+125°C	11	%	
		-55°C	12	%	
Settling Time	10V _{STEP} $A_V = -1$	0.1%	+25°C	0.4	μs
		0.01%	+25°C	1.5	μs
Power Supply Rejection Ratio	$\Delta V_S = \pm 10V$ to $\pm 20V$	Full	100	dB	
Supply Current	Quiescent, $V_{OUT} = 0V$, $I_{OUT} = 0mA$	Full	8	mA/Op Amp	
Minimum Supply Voltage	Functional Operation Only. Other Parameters May Vary.	+25°C	15	V	

NOTE:

1. $A_{VCL} = 10$, $f_O = 1kHz$, $V_{OUT} = 5V_{rms}$, $R_L = 600\Omega$, 10Hz to 100kHz, Minimum resolution of test equipment is 0.005%.

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